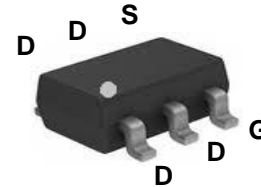


Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

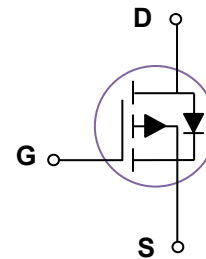
Dimensions SOT23-6



General Features

V_{DS}	-40V
I_D (at $V_{GS}=-10V$)	-7A
$R_{DS(ON)}$ (at $V_{GS}=-10V$)	35mΩ(Max)
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	50mΩ(Max)

Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
L4007	LMT6L7P04	SOT23-6	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Maximum	Units	
Drain-Source Voltage	V_{DS}	-40	V	
Gate-Source Voltage	V_{GS}	± 20	V	
Drain Current-Continuous	TC=25°C	I_D	-7	A
	TC=100°C	I_D	-4.2	A
Drain Current – Pulsed	I_{DM}	-28	A	
Single pulse avalanche energy	E_{AS}	40	mJ	
Maximum Power Dissipation	P_D	1.1	W	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C	
Thermal Characteristics				
Parameter	Symbol	Typ	Max	Unit
Thermal Resistance junction-case	$R_{\theta Jc}$		36	°C /W
Thermal Resistance junction-to-Ambient	$R_{\theta JA}$		80	°C /W

Electrical Characteristics ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-40V, V_{GS}=0V$			1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-1.6	-2.5	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=-10V, I_D=-5A$		28	35	m Ω
		$V_{GS}=-4.5V, I_D=-4A$		38	50	m Ω
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{DS}=-20V, V_{GS}=0V,$ $F=1.0\text{MHz}$		1320		pF
C_{oss}	Output Capacitance			116		pF
C_{rss}	Reverse Transfer Capacitance			89		pF
SWITCHING PARAMETERS						
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=-20V, I_D=-1A,$ $V_{GS}=-10V,$ $R_G=6\Omega$		12.8		nS
t_r	Turn-on Rise Time			8.7		nS
$t_{d(off)}$	Turn-Off Delay Time			65		nS
t_f	Turn-Off Fall Time			12.6		nS
Q_g	Total Gate Charge	$V_{DS}=-20V, I_D=-10A$ $, V_{GS}=-4.5V$		23		nC
Q_{gs}	Gate-Source Charge			2.9		nC
Q_{gd}	Gate-Drain Charge			4.3		nC
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=-1A$		0.72	1.4	V

Note:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristics

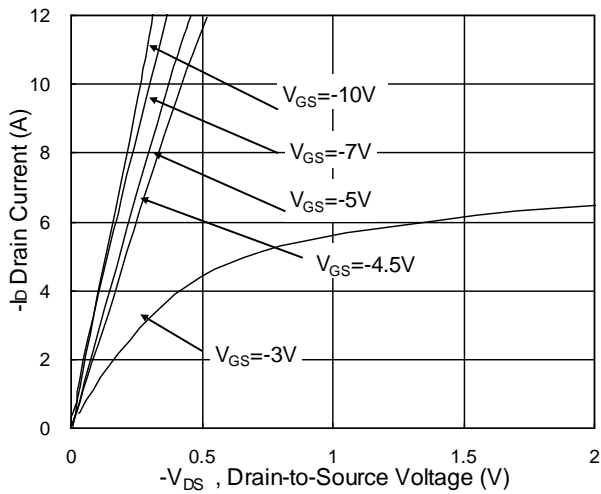


Fig.1 Typical Output Characteristics

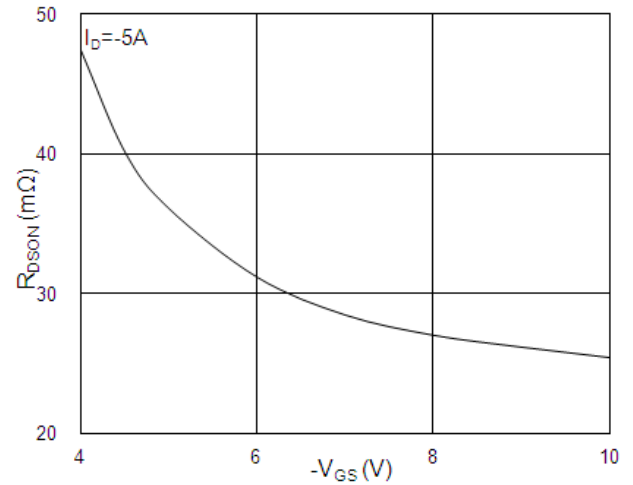


Fig.2 On-Resistance vs. Gate-Source Voltage

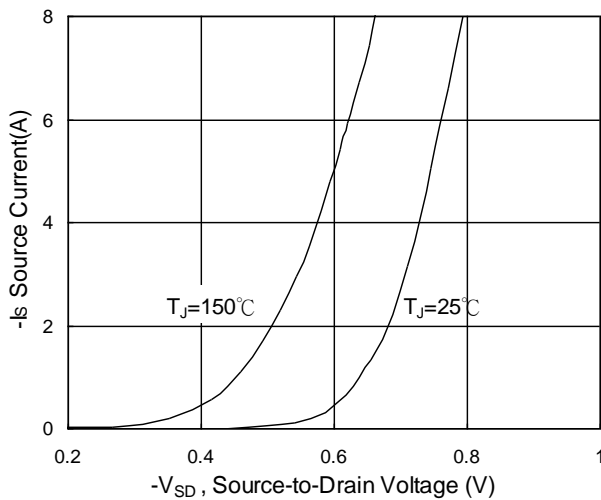


Fig.3 Forward Characteristics of Reverse

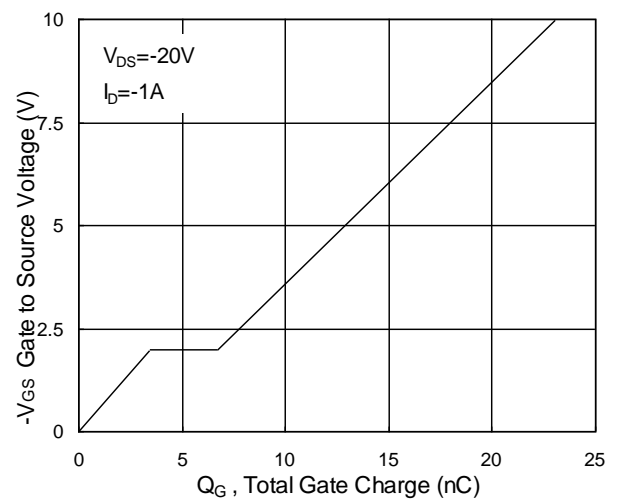


Fig.4 Gate Charge Characteristics

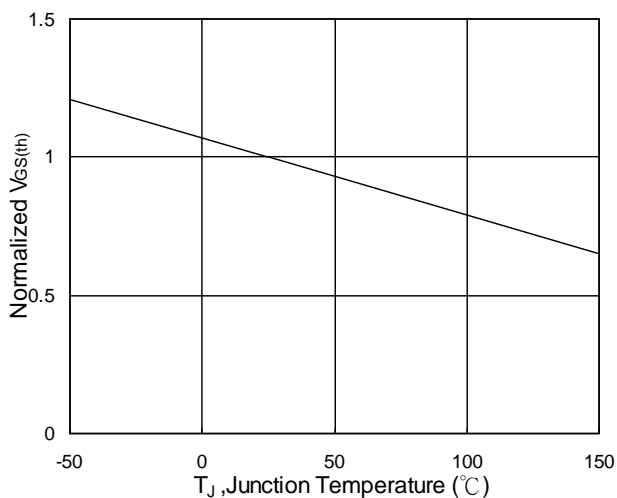


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

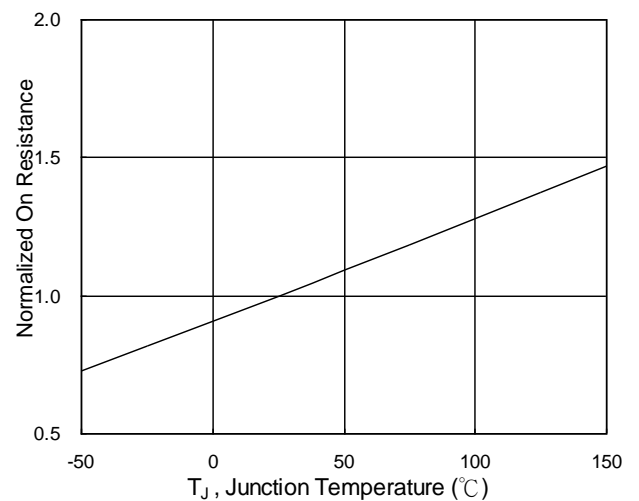


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

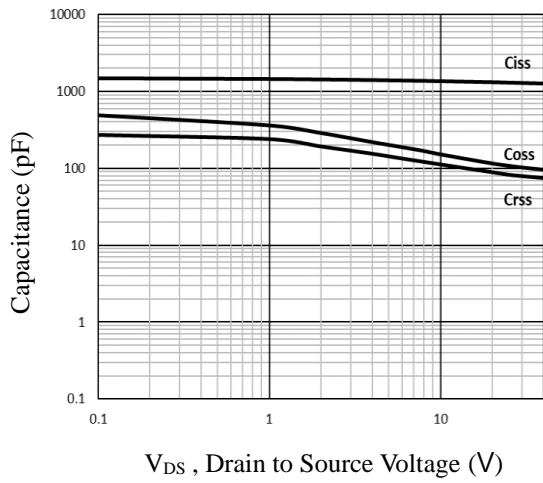


Fig.7 Capacitance Characteristics

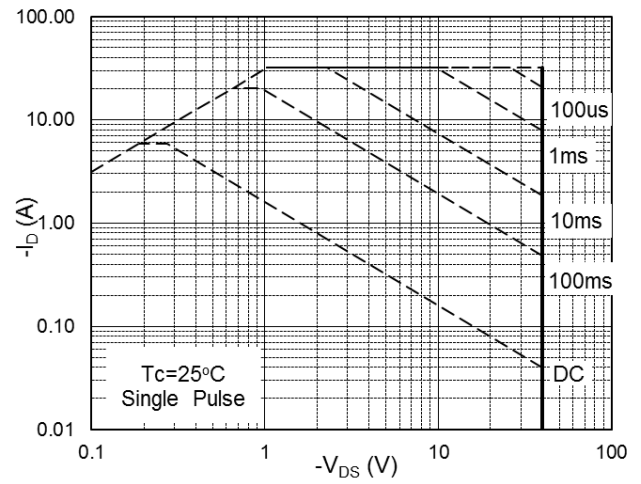


Fig.8 Safe Operating Area

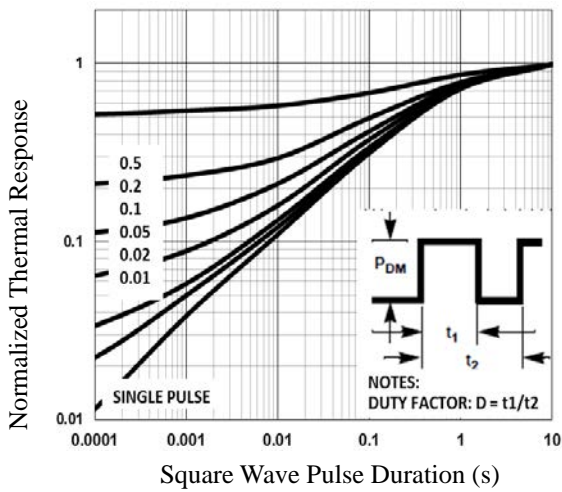
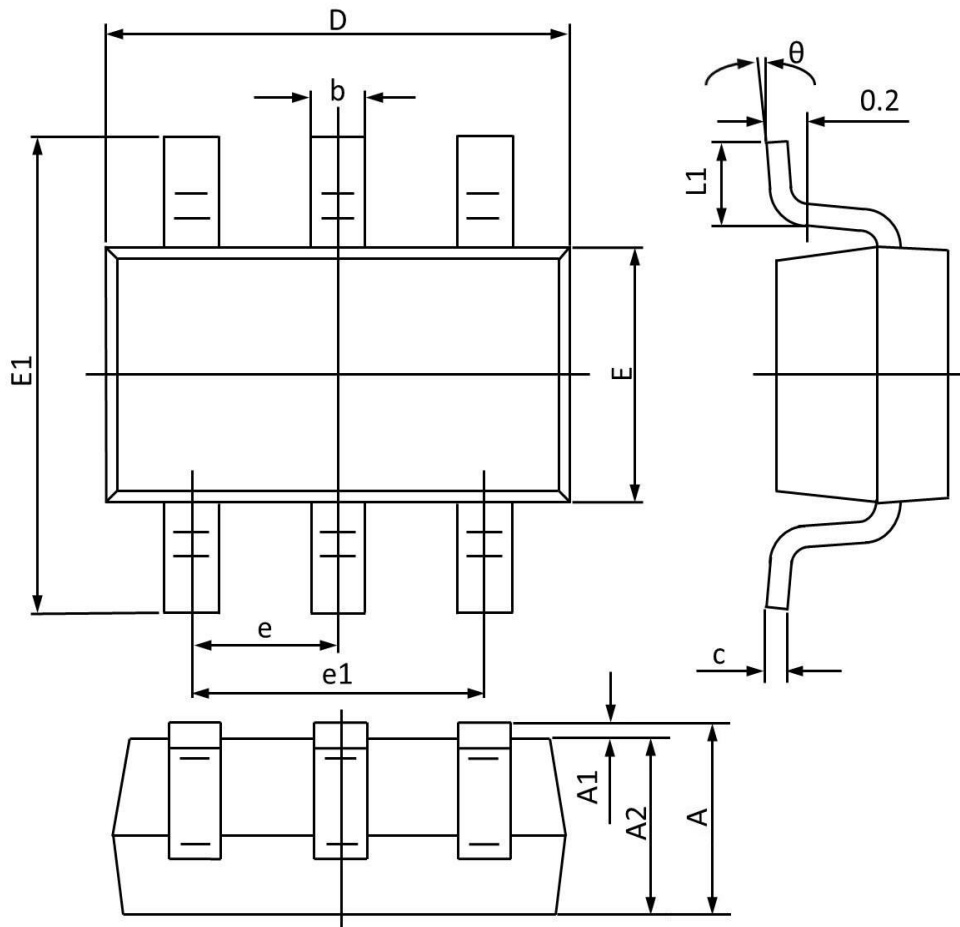


Fig.9 Normalized Transient Impedance

SOT23-6 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.450	-	0.057	-
A1	0.100	0.000	0.004	0.000
A2	1.300	1.050	0.051	0.041
b	0.500	0.300	0.020	0.012
c	0.200	0.100	0.008	0.004
D	3.100	2.700	0.122	0.106
E	1.800	1.400	0.071	0.055
E1	3.000	2.600	0.118	0.102
e	0.95BSC		0.037BSC	
e1	2.000	1.800	0.079	0.071
L1	0.600	0.300	0.024	0.012
θ	10°	0°	10°	0°

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